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| PATENT ASSIGNMENT COVER SHEET |
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Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT5801590

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| SUBMISSION TYPE: | NEW ASSIGNMENT |
| NATURE OF CONVEYANCE: | ASSIGNMENT |
| CONVEYING PARTY DATA | |
| Name | Execution Date |
| HON HAI PRECISION INDUSTRY CO., LTD. | 09/21/2018 |
| HONG FU JIN PRECISION INDUSTRY (ShenZhen) CO., LTD. | 09/21/2018 |
| RECEIVING PARTY DATA | |
| Name: | FOXCONN INTERCONNECT TECHNOLOGY LIMITED |
| Street Address: | Cricket Square, Hutchins Drive, P.O. Box 2681, Grand Cayman KY1-1111, Cayman Islands |
| City: | Grand Cayman |
| State/Country: | CAYMAN ISLANDS |
| PROPERTY NUMBERS Total: 1 | |
| Property Type | Number |
| Patent Number: | 9120432 |
| CORRESPONDENCE DATA | |
| Fax Number: | (408)919-8353 |
| <i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i> | |
| Phone: | 4089196137 |
| Email: | joseph.chung@fit-foxconn.com,sou-proce7@foxconn.com,sou-proce7@fit-foxconn.com |
| Correspondent Name: | WEI TE CHUNG |
| Address Line 1: | 408 E PLUMERIA DR. |
| Address Line 4: | SAN JOSE, CALIFORNIA 95134 |
| ATTORNEY DOCKET NUMBER: | US51816 |
| NAME OF SUBMITTER: | WEI TE CHUNG |
| SIGNATURE: | /WEI TE CHUNG/ |
| DATE SIGNED: | 11/04/2019 |
| Total Attachments: 2 | |
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| source=US51816190730Transfer#page2.tif | |

PATENT ASSIGNMENT AGREEMENT

Hon Hai Precision Industry Co., Ltd. and Hongfujin Precision Industry (Shenzhen) Co., Ltd. (the "ASSIGNOR") are owners of patents listed in Exhibit A, (the "Patents"). Foxconn Interconnect Technology Limited (the "ASSIGNEE") desires to acquire rights in and to the Patents, and has entered into an Assets Transfer Agreement (the "Transfer Agreement") with ASSIGNOR, effective May 28, 2018, whereby terms, conditions and considerations for the assignment of the PATENTS were agreed upon.

Therefore, for valuable consideration, the receipt of which is acknowledged, ASSIGNOR hereby assigns to ASSIGNEE all of its right, title, and interest in the invention and Patents to ASSIGNEE for the entire term of the Patents and any reissues or extensions thereof, and for the entire term of any patents, reissues, or extensions that may issue from foreign applications, divisions, continuations in whole or in part, or substitute applications filed claiming the benefit of the Patents. The right, title, and interest conveyed in this Assignment is to be held and enjoyed by ASSIGNEE and ASSIGNEE's successors as fully and exclusively as it would have been held and enjoyed by ASSIGNOR prior to making this assignment.

ASSIGNOR further agrees to: (a) cooperate with ASSIGNEE in the protection of the patent rights and prosecution and protection of foreign counterparts; (b) execute, verify, acknowledge and deliver all such further papers, including patent applications and instruments of transfer; and (c) perform such other acts as ASSIGNEE lawfully may request to obtain or maintain the Patents and any and all applications and registrations for the invention in any and all countries.

In the event of any conflicts between this Agreement and the Transfer Agreement, the Transfer Agreement shall prevail.

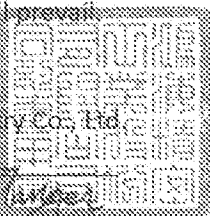
ASSIGNOR

Hon Hai Precision Industry Co., Ltd.

By: [Signature]

Title: General Manager

Date: 2018.9.18

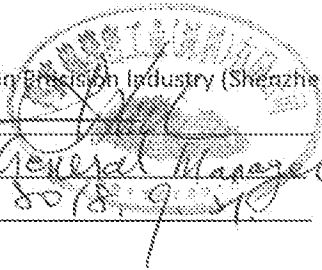


Hongfujin Precision Industry (Shenzhen) Co., Ltd.

By: [Signature]

Title: General Manager

Date: 2018.9.18



For and on behalf of
FOXCONN INTERCONNECT

ASSIGNEE

Foxconn Interconnect Technology Limited
FOXCONN INTERCONNECT TECHNOLOGY LIMITED

By: [Signature]

Title: Vice President

Date: 2018.9.18

[Signature]
Authorized Signature(s)

2018TW-L-K-2208



EXHIBIT A

| Appl. No. | Country |
|-----------|---------|
| 13/847054 | US |
| 13/922838 | US |
| 14/014780 | US |
| 14/066705 | US |
| 14/262879 | US |
| 14/291266 | US |
| 14/587288 | US |
| 14/311589 | US |
| 14/546182 | US |
| 14/754184 | US |
| 14/540204 | US |
| 14/595218 | US |
| 14/560072 | US |
| 14/656444 | US |
| 14/680541 | US |
| 14/614801 | US |
| 14/481889 | US |
| 14/510977 | US |
| 14/525814 | US |
| 29/513189 | US |
| 14/847741 | US |
| 14/558952 | US |
| 14/725888 | US |
| 14/718538 | US |
| 14/842233 | US |
| 14/858081 | US |
| 14/788102 | US |
| 14/687591 | US |
| 14/688656 | US |
| 14/819925 | US |
| 14/687645 | US |
| 14/753832 | US |
| 14/755824 | US |
| 14/821120 | US |
| 14/755846 | US |

| Appl. No. | Country |
|----------------|---------|
| 14/755867 | US |
| 14/755867 | US |
| 14/755911 | US |
| 14/821257 | US |
| 14/821131 | US |
| 14/821142 | US |
| 14/835334 | US |
| 14/812673 | US |
| 14/585467 | US |
| 14/716383 | US |
| 14/583836 | US |
| 14/549739 | US |
| 14/641836 | US |
| 14/642402 | US |
| 14/591109 | US |
| 29/480040 | US |
| 29/470572 | US |
| 14/310078 | US |
| 14/182300 | US |
| 13/034689 | US |
| 15/588800 | US |
| 29/589321 | US |
| 特願 2015-003057 | JP |
| 特願 2015-071344 | JP |
| 特願 2015-065982 | JP |
| 特願 2015-016633 | JP |
| 特願 2015-079850 | JP |
| 特願 2015-019129 | JP |
| 特願 2015-019126 | JP |
| 特願 2015-123661 | JP |
| 特願 2015-138584 | JP |
| 特願 2015-128532 | JP |
| 特願 2015-025150 | JP |
| 002335117-0001 | EC |
| 102013005587.9 | DE |



TECHNOLOGY LIMITED
 (Authorized Signatures)

2018TW-L-K-2208

